

SH7239 Group

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Rev. 1.01

Using User Program Mode

Jun. 15, 2012

Summary

This application note describes an example to run the flash memory reprogramming program in SH7239 microcomputers (MCUs) user program mode. An external device which is connected to the SH7239 stores the data to write to the flash memory, and communicates with the flash memory using the Serial Communication Interface with FIFO.

The flash memory reprogramming program described in this application note is stored on the SH7239 user MAT. The simple flash API for SH2 and SH2A (Standard API) provided by the Renesas Electronics is used to reprogram the flash memory.

Target Device

SH7239 MCU

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1. Introduction

1.1 Specifications

This application programs, erases, and reads the flash memory using user program mode. User program mode handles programming, erasing, and reading with a desired interface. This application uses the serial communication between the host computer and the SH7239 to handle these processing.

When the SH7239 receives the flash memory reprogramming/erasing command (user control command) from the host computer while executing the user application, the SH7239 programs or erases the flash memory. When it receives the flash memory reading command from the host computer, it reads the flash memory.

Figure 1 shows the system configuration of this application.

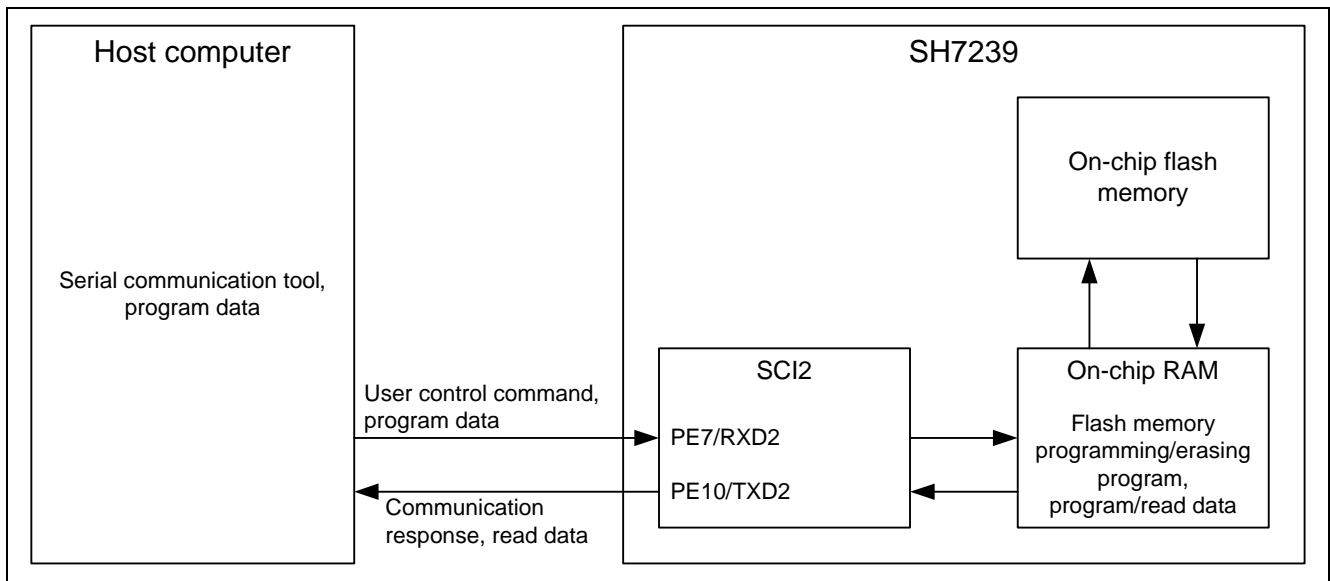


Figure 1 System Configuration

1.2 Modules Used

- Serial Communication Interface (SCI)
- On-chip Flash-dedicated Sequencer (FCU)

1.3 Applicable Conditions

MCU	SH7239 (R5F72395ADFP: 512-KB flash memory version)
Power Supply Voltage	3.3 V
Operating Frequency	Internal clock: 160 MHz Bus clock: 40 MHz Peripheral clock: 40 MHz
Integrated Development Environment	Renesas Electronics Corporation High-performance Embedded Workshop Ver.4.07.00
C Compiler	Renesas Electronics SuperH RISC engine Family C/C++ compiler package Ver.9.03 Release 02
Compiler Options	Default setting in the High-performance Embedded Workshop (-cpu=sh2a -debug -gbr=auto -global_volatile=0 -opt_range=all -infinite_loop=0 -del_vacant_loop=0 -struct_alloc=1)

1.4 Related Application Note

For more information, refer to the following application note:

- SH Family Simple Flash API for SH2 and SH2A

2. Overview

This application uses the Serial Communication Interface (SCI) to connect the SH7239 with the external device. SH7239 uses a dedicated sequencer (FCU) to program or erase the on-chip flash memory.

2.1 Overview of Modules

2.1.1 Serial Communication Interface (SCI)

SCI supports both asynchronous and clocked synchronous serial communication. It also supports full-duplex communication and allows double-buffering both at transmitter and receiver to transmit/receive the serial data continuously at high speed.

This application uses the SCI for the handshake between the SH7239 and an external device, and to transmit/receive the flash memory reprogram data.

Figure 2 shows the SCI block diagram.

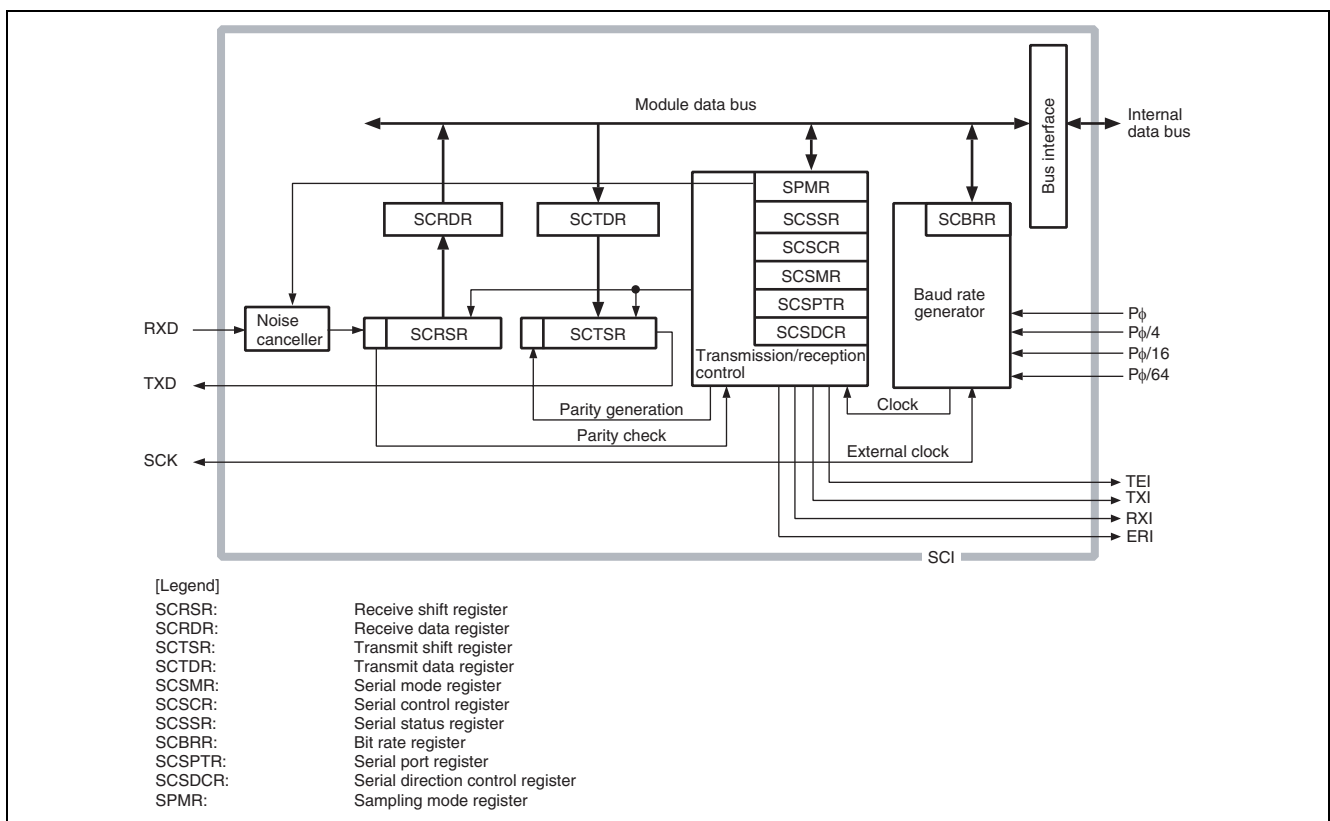


Figure 2 SCI Block Diagram

2.1.2 On-chip Flash-dedicated Sequencer (FCU)

The SH7239 group MCU programs or erases the flash memory using its FCU.

Figure 3 shows the on-chip flash memory block diagram.

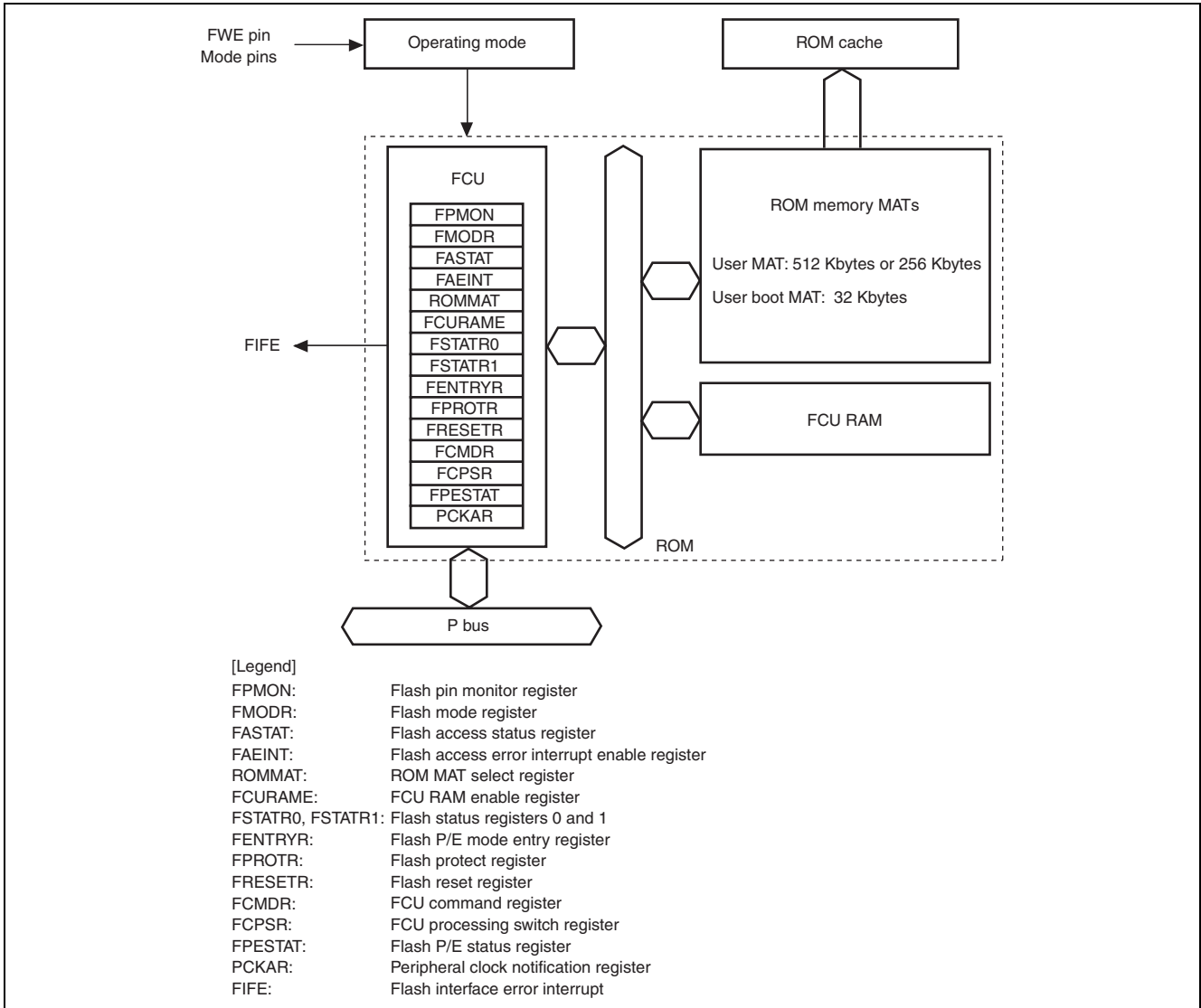


Figure 3 On-chip Flash Memory Block Diagram

2.2 Programming/Erasing the On-chip Flash Memory

SH7239 uses its FCU to program and erase the on-chip flash memory. This section describes how to reprogram the on-chip flash memory. For more information, refer to the SH7214 Group, SH7239 Group User's Hardware Manual. This application uses the Standard API for programming and erasing the on-chip flash memory. For more information about the API, refer to the related application note.

2.2.1 Preparing to Program/Erase the On-chip Flash Memory

To use the FCU, the user must store the firmware for the FCU (FCU firmware) in the FCURAM. After transferring the FCU firmware, issue the FCU command to allow the FCU to program or erase the on-chip flash memory.

As the FCU firmware is stored in the FCU firmware area on the MCU, user must transfer the FCU firmware to the FCURAM when the MCU is activated. Make sure to enable accessing the FCURAM by the register setting, because accessing the FCURAM is not allowed when the MCU is activated.

Figure 4 shows the flow chart for preparing to use the FCU command.

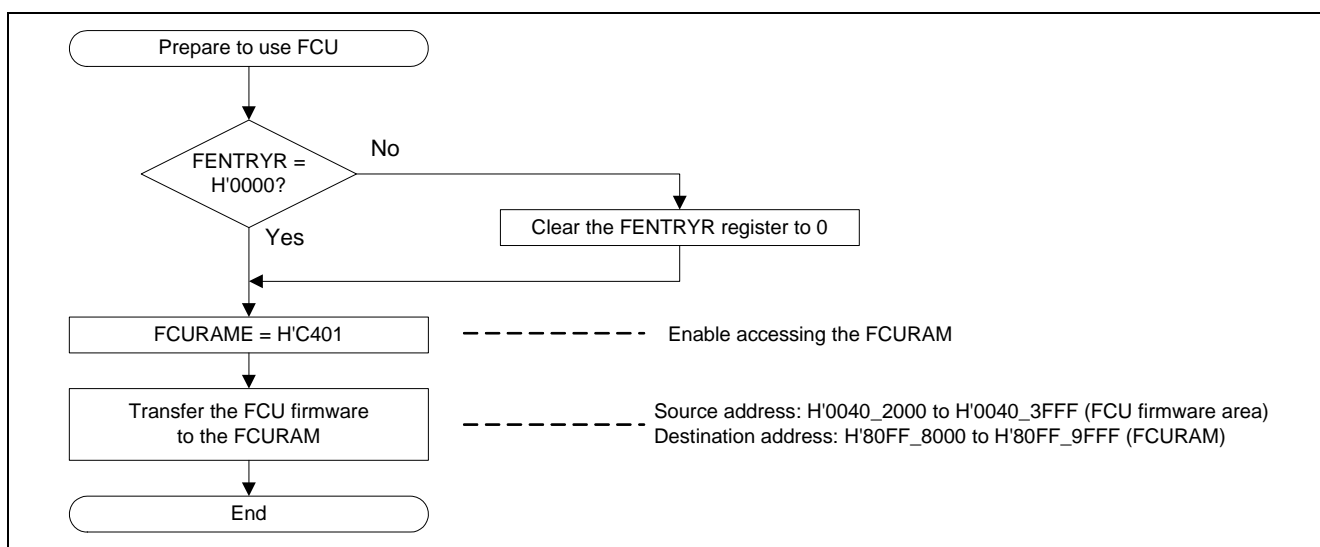


Figure 4 Flow Chart for Preparing to Use the FCU Command

2.2.2 Erasing the On-chip Flash Memory

SH7239 on-chip flash memory is divided into multiple blocks to be erased in blocks. After transferring the FCU firmware, program the erase command ⁽¹⁾ and execute command to the erase target block address, and FCU erases blocks.

Figure 5 shows the block division of the SH7239. Table 1 lists each block and address. Figure 6 shows the flow chart ⁽²⁾ for erasing the on-chip flash memory.

- Notes: 1. Erase command can be used at any program/erase address in the on-chip flash memory.
2. The flow chart in Figure 6 does not follow the standard API.

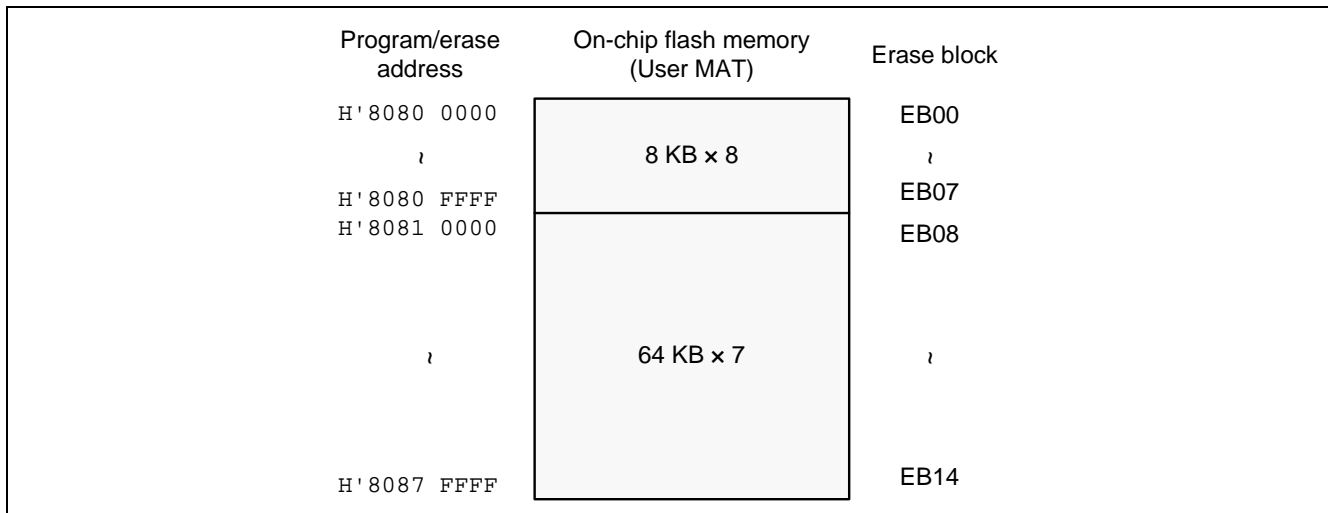


Figure 5 Dividing the On-chip Flash Memory Erase Block

Table 1 Erase Block and Address

Erase Block	Actual Address	Program/Eraser Address	Capacity
EB00	H'0000_0000 to H'0000_1FFF	H'8080_0000 to H'8080_1FFF	8 KB
EB01	H'0000_2000 to H'0000_3FFF	H'8080_2000 to H'8080_3FFF	
EB02	H'0000_4000 to H'0000_5FFF	H'8080_4000 to H'8080_5FFF	
EB03	H'0000_6000 to H'0000_7FFF	H'8080_6000 to H'8080_7FFF	
EB04	H'0000_8000 to H'0000_9FFF	H'8080_8000 to H'8080_9FFF	
EB05	H'0000_A000 to H'0000_BFFF	H'8080_A000 to H'8080_BFFF	
EB06	H'0000_C000 to H'0000_DFFF	H'8080_C000 to H'8080_DFFF	
EB07	H'0000_E000 to H'0000_FFFF	H'8080_E000 to H'8080_FFFF	64 KB
EB08	H'0001_0000 to H'0001_FFFF	H'8081_0000 to H'8081_FFFF	
EB09	H'0002_0000 to H'0002_FFFF	H'8082_0000 to H'8082_FFFF	
EB10	H'0003_0000 to H'0003_FFFF	H'8083_0000 to H'8083_FFFF	
EB11	H'0004_0000 to H'0004_FFFF	H'8084_0000 to H'8084_FFFF	
EB12	H'0005_0000 to H'0005_FFFF	H'8085_0000 to H'8085_FFFF	
EB13	H'0006_0000 to H'0006_FFFF	H'8086_0000 to H'8086_FFFF	
EB14	H'0007_0000 to H'0007_FFFF	H'8087_0000 to H'8087_FFFF	

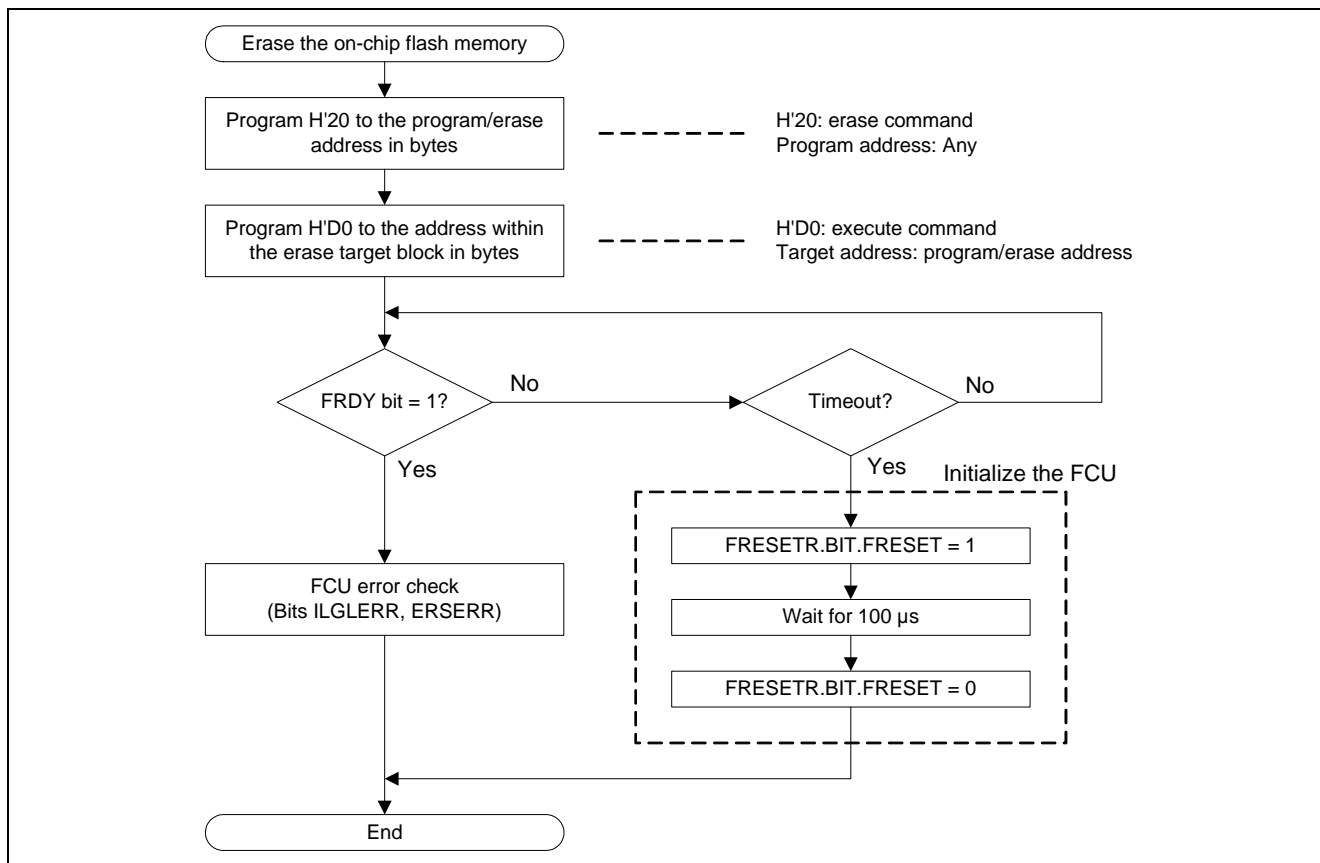


Figure 6 Flow Chart for Erasing the On-chip Flash Memory

2.2.3 Programming the On-chip Flash Memory

Programming data in the on-chip flash memory can be allowed only on the erased area, and program data to the user MAT in units of 256-byte at a time. FCU programs the on-chip flash memory by issuing the command to the FCU, as same as erasing. Issue the program command and program size⁽¹⁾ to the program/erase address, and set⁽²⁾ the program data (256 bytes) to the program target address⁽³⁾.

Figure 7 shows the flow chart for programming the flash memory⁽⁴⁾.

Notes: 1. Programming data to the user MAT and user boot MAT must be in units of 256-byte (Issue the command H'80).

2. Program the program data to the program/erase address in words.

3. Program target address is the program address plus H'8080_0000 (program/erase address).

4. Flow chart in Figure 7 does not follow the standard API.

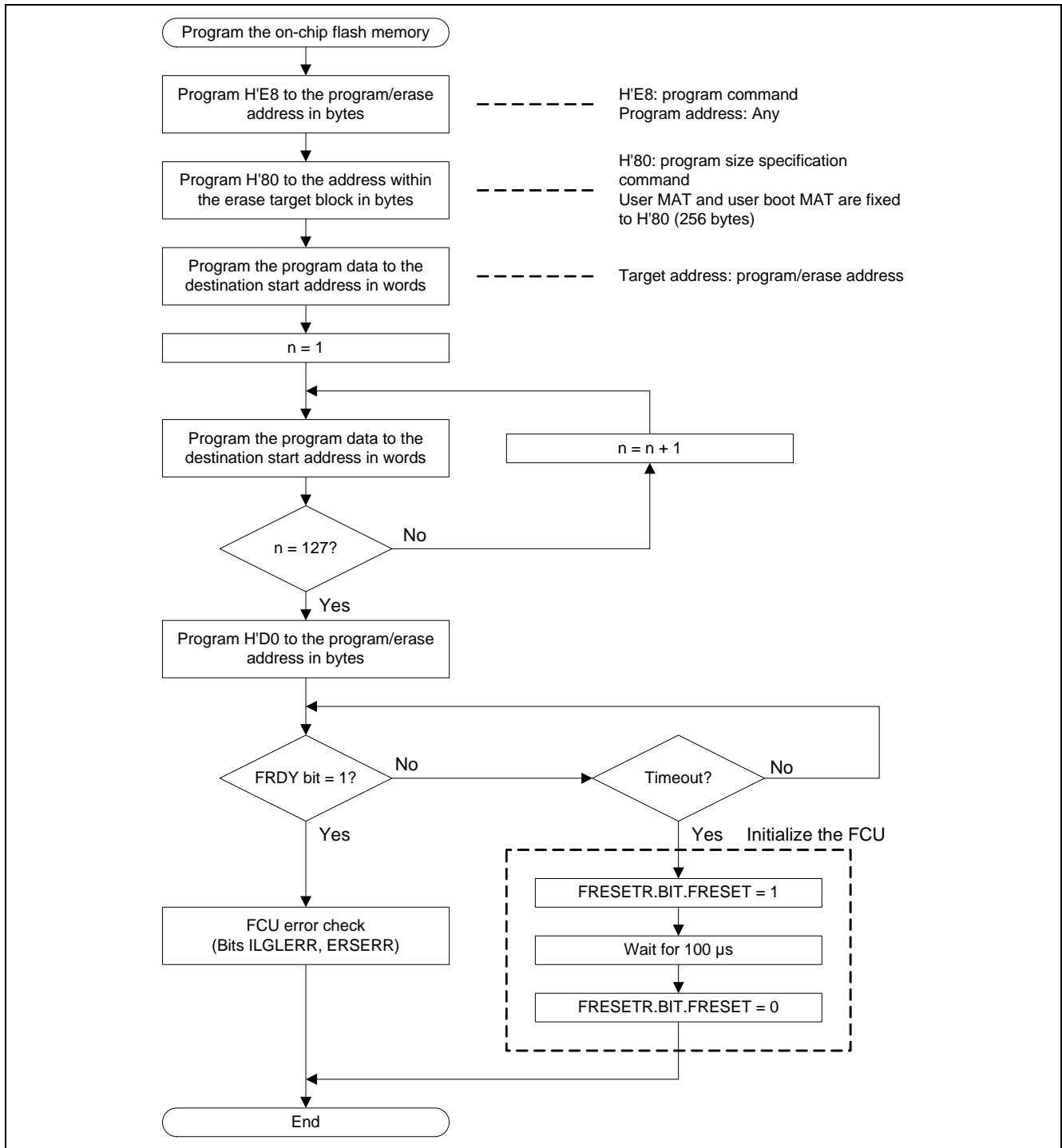


Figure 7 Programming the Flash Memory

2.3 Flash Program Data Buffer

This application has the buffer area to hold the program data in the SH7239 on-chip RAM. The capacity of the buffer area is 256 bytes, which is equivalent to a flash programming.

Figure 8 shows the operation image of the buffer. Table 2 lists the data buffer area address ^(note).

Note: Data buffer area is divided into sections. Change the section allocation address to set the desired buffer area address. Make sure not to use the same area as the on-chip program in on-chip RAM.

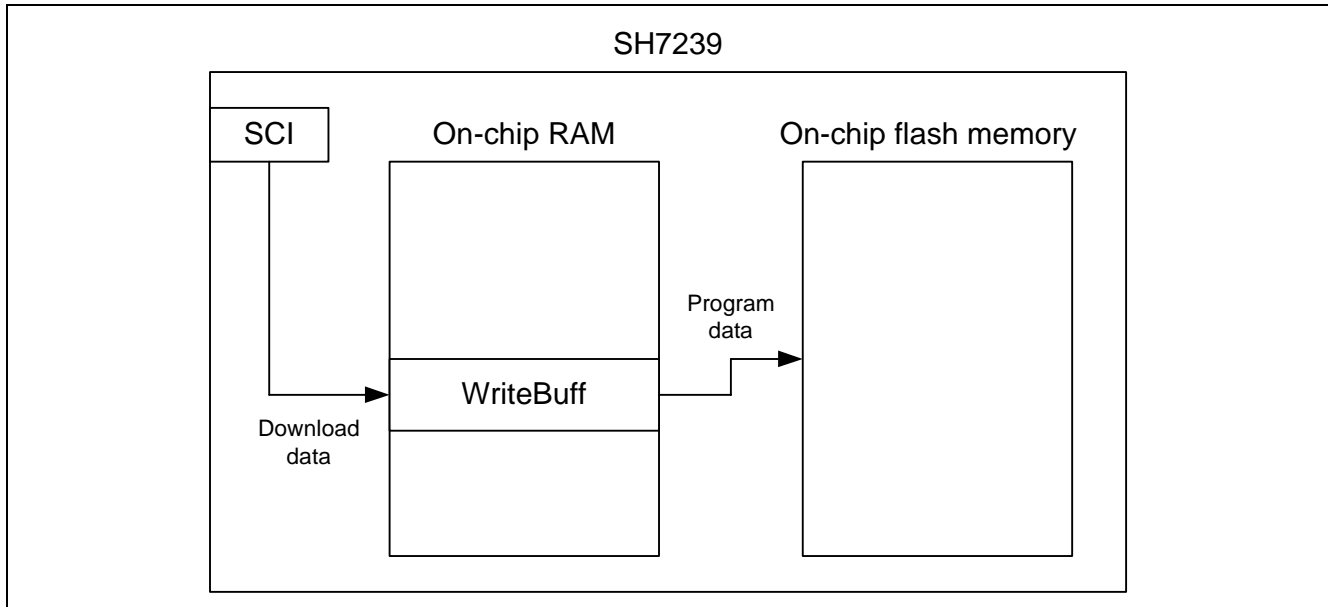


Figure 8 Buffer Operating Image

Table 2 Data Buffer Area Address

Buffer Name	Address	Capacity
WriteBuff	H'FFF8_1000 to H'FFF8_10FF	256 bytes

3. Sample Program External Specifications

This application allocates the flash memory reprogramming sample program including main function (sample program) in EB00 block in the user MAT (address: H'0000 0000 to H'0000 1FFF). Sample program consists of the user application (main function), serial communication program, flash memory reprogramming program, and Standard API.

Figure 9 shows the sample program configuration.

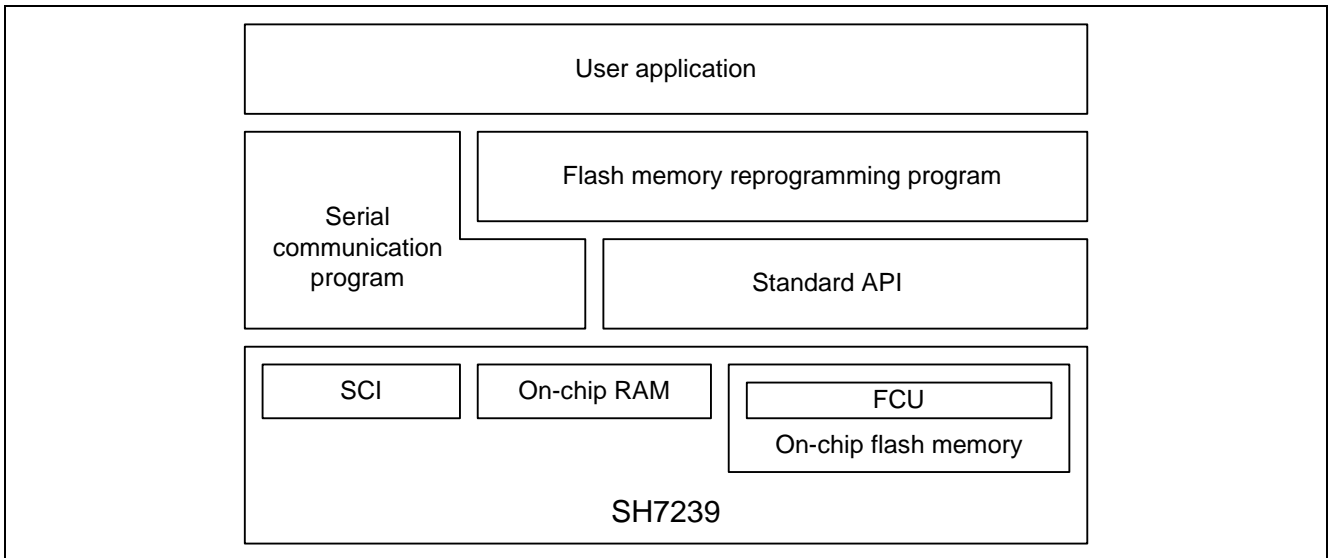


Figure 9 Sample Program Configuration

3.1 On-chip Flash Memory Programming/Erasing Specifications

The target area to program or erase in the on-chip flash memory is the user MAT (EB01 to EB14 block address: H'8080 2000 to H'8087 FFFF) other than EB00 block where the sample program is allocated.

When the sample program receives the flash memory programming/erasing command from the host computer, it erases blocks in the program/erase target area in the on-chip flash memory, and programs the specified size of data in the on-chip flash memory from the destination start address which is specified by the host computer.

Figure 10 shows the image of programming and erasing the flash memory by the sample program.

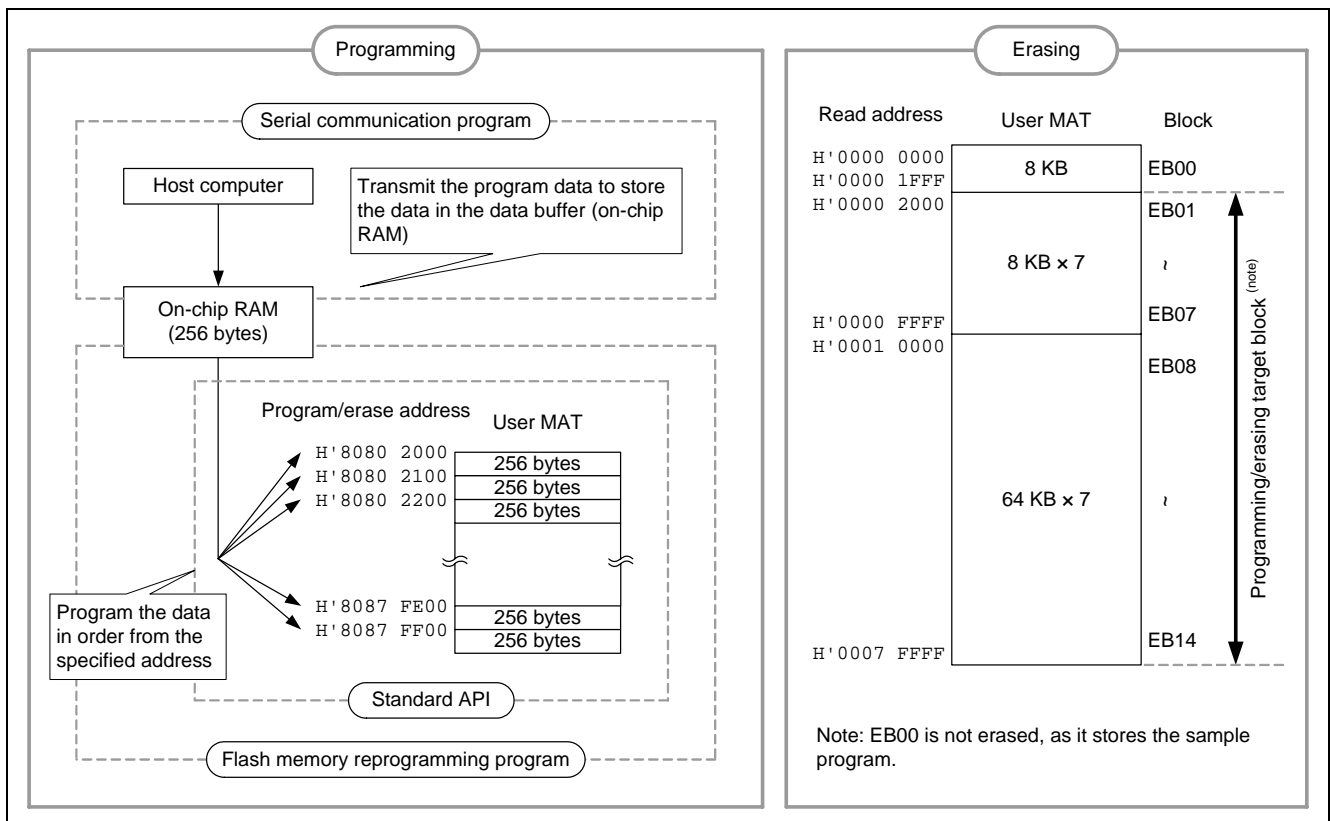


Figure 10 Programming and Erasing the Flash Memory

3.2 Sample Program Operation

This application executes the serial communication with the host computer and transmits/receives the user control commands for communication and data to program, erase and read the flash memory. It uses SCI channel 2 (SCI2) for the serial communication. The sample program these processing to control the flash memory in on-chip RAM.

The sample program checks whether the flash memory is program-/erase-enabled or not. When the flash memory is program-/erase-enabled, the sample program requests the host computer to issue the user control command for communication; otherwise, the sample program polls the FWE bit until the flash memory is program-/erase-enabled (note).

Note: To use the SH7239 user program mode, set the FWE pin to low after the reset is canceled, and set the FWE pin to high after the MCU operating mode is fixed.

Figure 11 shows the main processing flow chart.

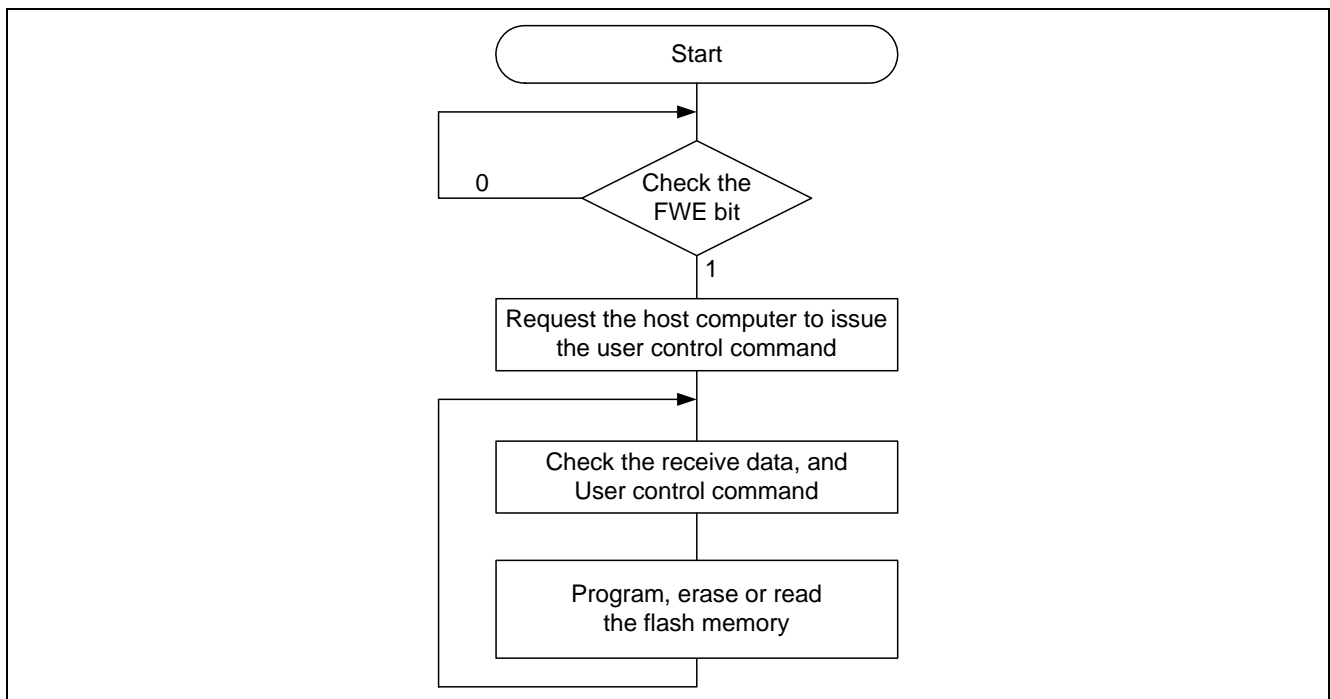


Figure 11 Main Processing Flow Chart

Table 3 lists the user control commands for communication from the host computer. Table 4 lists the notification from the SH7239.

When an error occurs while programming or erasing the on-chip flash memory, the sample program notifies the error end (RET_NG) to the host computer and enters an infinite loop. Add the error processing as appropriate.

Table 3 User Control Commands from the Host Computer to SH7239

Command Name	Value	Description
Program/erase the flash memory (CMD_WRITE)	H'50	Erases blocks (EB01 to EB14), and then programs the specified bytes of data from the specified address
Read the flash memory (CMD_READ)	H'52	Reads the specified bytes of data from the specified address in the on-chip flash memory

Table 4 Notifications from the SH7239 to the Host Computer

Notification Name	Value	Description
Normal end (RET_OK)	H'00	Notifies the host computer that the command handling ends successfully
Error end (RET_NG)	H'01	Notifies the host computer that the command handling ends in error
Transmit request (RET_REQ)	H'11	Notifies the host computer that the sample program is requesting to transmit the user control command or the program data

3.2.1 Programming or Erasing the On-chip Flash Memory

The sample program erases blocks and programs the specified bytes of data from the destination start address in the on-chip flash memory by the flash memory programming/erasing command (CMD_WRITE).

When the sample program receives the flash memory programming/erasing command (CMD_WRITE) from the host computer, it erases blocks to EB01 to EB14. After erasing blocks, the sample program notifies the transmission request (RET_REQ) to the host computer. Then, the sample program receives the destination start address (in units of 4-byte) and program data size (in units of 4-byte) from the host computer (8 bytes in total), and it notifies the transmission request (RET_REQ) of the program data to the host computer, and transitions to programming.

Specify the read address (H'0000 2000 to H'0007 FFFF)^(note) within blocks EB01 to EB14 as the program destination start address. Otherwise, the sample program notifies the error end (RET_NG) to the host computer to enter an infinite loop. As the sample program does not include the error check when the specified address is not on the user MAT, do not specify the address that is out of bounds.

Note: Specify the read address as the program destination start address to use the Standard API. The Standard API converts the read address into the program/erase address internally.

After the sample program transitions to programming, it notifies the transmission request (RET_REQ) of the program data at every 256-byte data is received (a flash programming). The host computer must transmit 256-byte data for each transmission request (RET_REQ).

The sample program programs the flash memory at every 256-byte data is received. When the last program data size is less than 256-byte, the sample program pads the remaining data to H'FF, to be in units of 256-byte.

When the total number of programming the flash memory reaches the program data size, the sample program notifies the normal end (RET_OK) to the host computer.

Figure 12 shows the communication command sequence when programming or erasing the flash memory by the sample program.

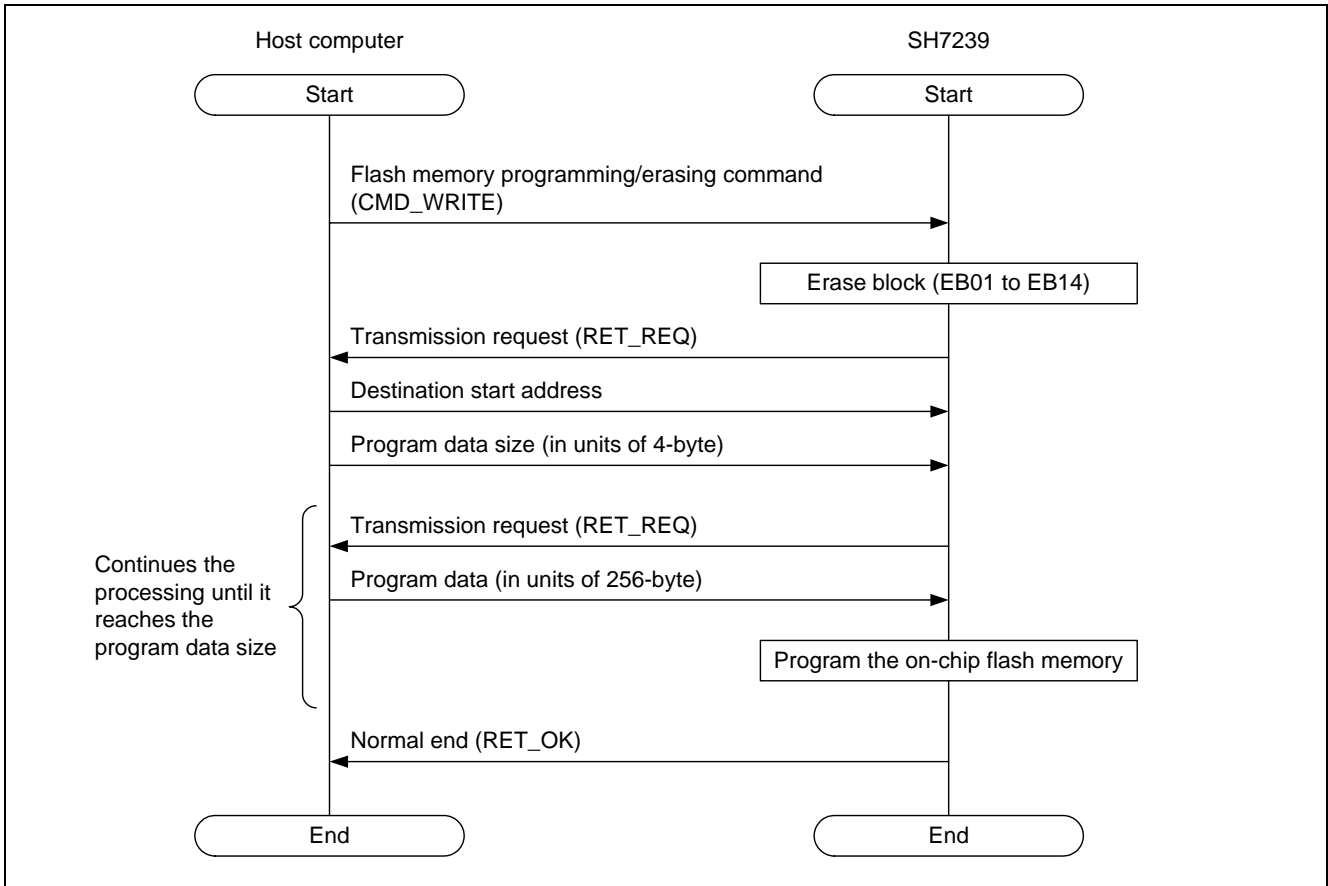


Figure 12 Communication Command Sequence When Programming/Erasing the Flash Memory

3.2.2 Reading the On-chip Flash Memory

The sample program reads the specified bytes of data from the destination start address in the on-chip flash memory and transmits the read data to the host computer by the flash memory reading command (CMD_READ).

When the sample program receives the flash memory reading command (CMD_READ), it notifies the transmission request (RET_REQ) to the host computer. Then, the sample program receives the destination start address (in units of 4-byte) and read data size (in units of 4-byte) from the host computer (8 bytes in total), and it reads the specified size of data from the destination address, and transmits the data to the host computer.

Specify the read address (H'0000 0000 to H'0007 FFFF) within blocks EB00 to EB14 (user MAT) as the read destination start address. Otherwise, the sample program does not read the flash memory, notifies the error end (RET_NG) to the host computer to enter an infinite loop. As the sample program does not include the error check when the specified address is not on the user MAT, do not specify the address that is out of bounds.

Figure 13 shows the communication command sequence when reading the flash memory.

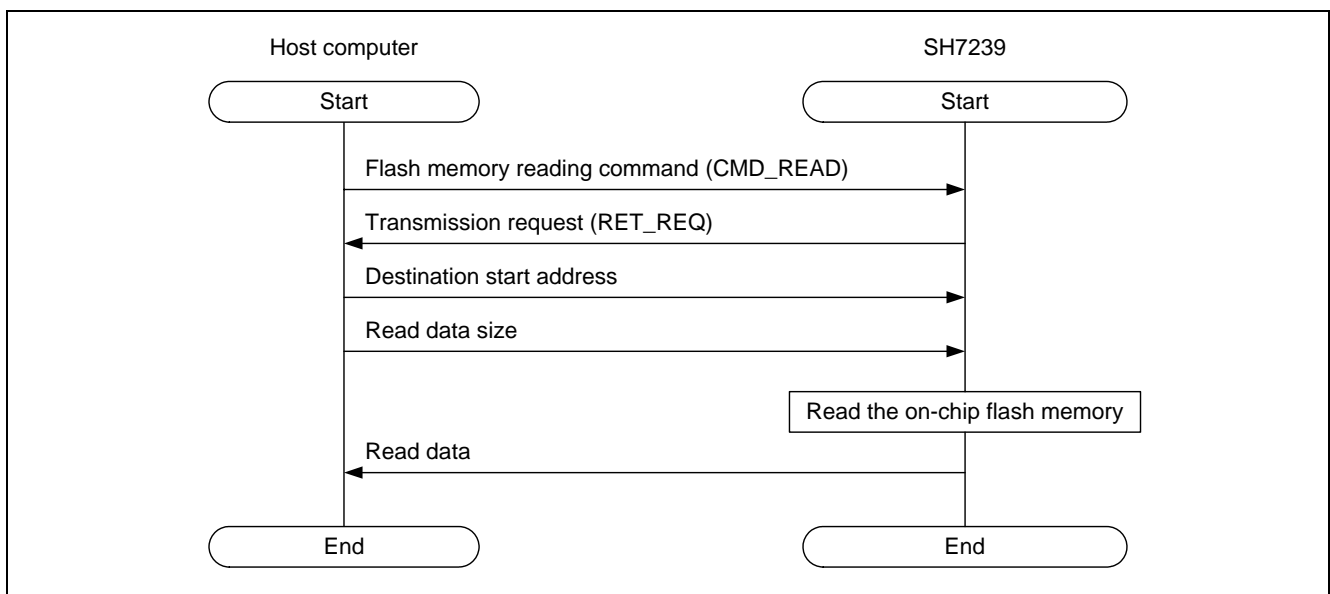


Figure 13 Communication Command Sequence When Reading the Flash Memory

4. Sample Program Internal Specifications

4.1 Modules

Table 5 lists the specifications of sample program modules.

Table 5 Sample Program Modules

Type	Module Name	Function Name	Description	Flow Chart
User application	Main processing	main	Executes the user application	See Figure 14
Flash memory reprogramming	Flash memory programming/erasing	ocf_write	Programs or erasing the flash memory	See Figure 15 and Figure 16
	Flash memory reading	ocf_read	Reads the flash memory	See Figure 17
	Flash memory program-/erase-enabled check	ocf_pe_chk	Checks that the flash memory is program-/erase-enabled	See Figure 18
Serial communication control	SCI configuration	io_sci_init	Configures the SCI (channel 2)	–
	SCI receive data existence check	io_sci_chk_rcv	Checks if the receive data is stored in the SCRDR register	–
	SCI transmit	io_sci_snd	Transmits one-byte data	–
	SCI receive	io_sci_rcv	Receives the specified bytes of data	–
Standard API	Block erase	R_FlashErase	Erases the data in the specified block	–
	Flash memory programming	R_FlashWrite	Programs the data in the specified address	–

4.2 Variable Used

Table 6 lists a variable used in the sample program.

Table 6 Variable

Variable Label Name	Description	Module to Use
unsigned char WriteBuff[256]	Stores the program data	ocf_write

4.3 Register Settings

Table 7 lists the register settings for the peripherals.

Table 7 SCI (Channel 2) Register Settings in the Sample Program

Register Name	Address	Setting	Description
Serial mode register_2 (SCSMR_2)	H'FFFF 9000	H'00	<ul style="list-style-type: none"> C/A# = "0": Asynchronous mode CHR = "0": 8-bit data PE = "0": Disables to add and check the parity bit STOP = "0" 1 stop bit MP = "0": Disables the multiprocessor mode CKS [1:0] = "B'00": Peripheral clock
Bit rate register_2 (SCBRR_2)	H'FFFF 9002	D'129	Bit rate = 9600 bps (Peripheral clock = 40 MHz)
Serial control register_2 (SCSCR_2)	H'FFFF 9004	H'30	<ul style="list-style-type: none"> TE = "1": Enables the transmitter RE = "1": Enables the receiver
Port E control register L3 (PECRL3)	H'FFFE 3A12	H'0600	PE10MD [2:0] = "B'110": Outputs TXD2 (SCI)
Port E control register L2 (PECRL2)	H'FFFE 3A14	H'6000	PE7MD [2:0] = "B'110": Inputs RXD2 (SCI)

4.4 Flow Charts

This section describes the flow charts of the sample program.

4.4.1 Main Flow Chart

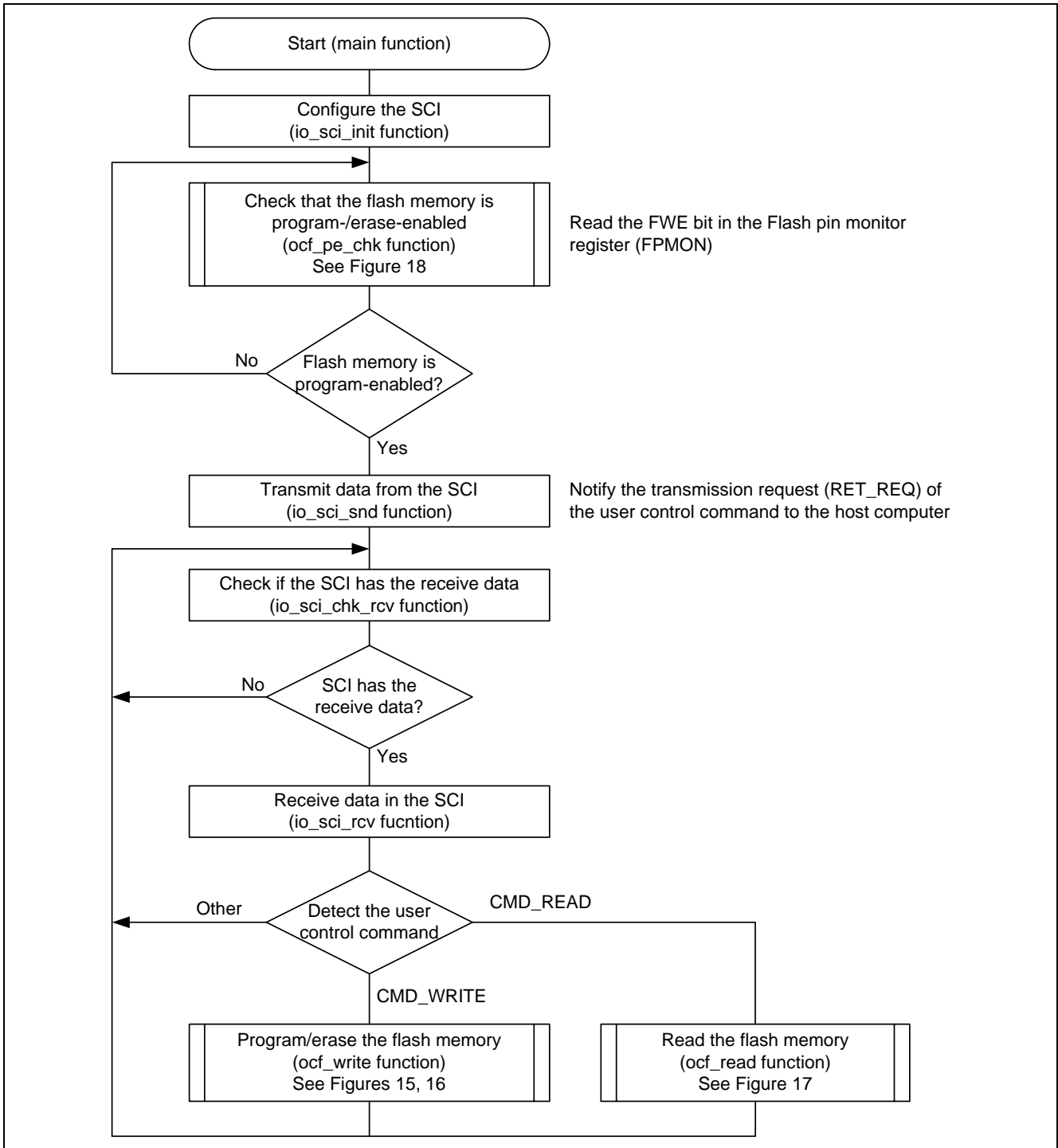


Figure 14 Main Processing Flow Chart

4.4.2 Programming/Erasing the Flash Memory

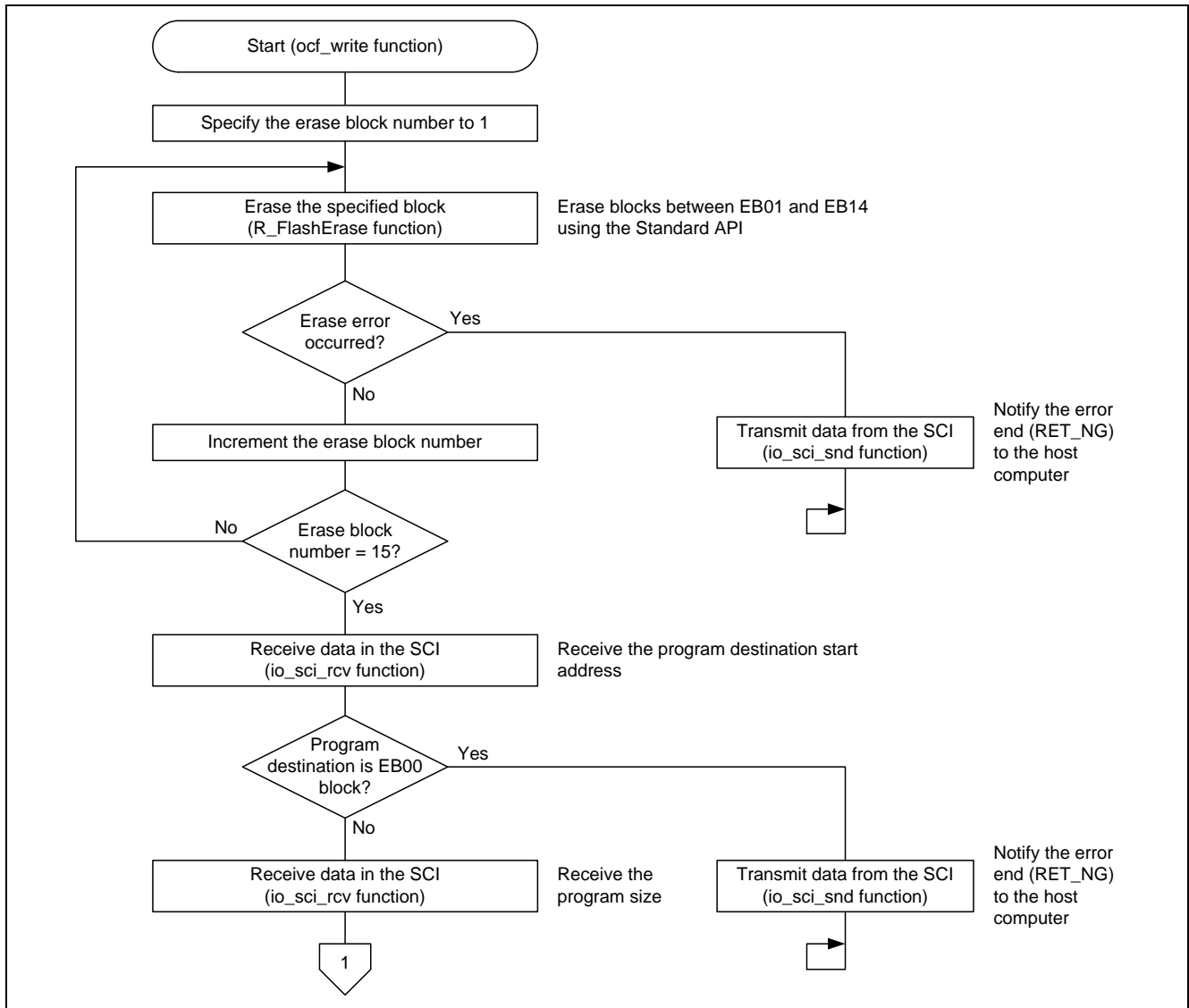


Figure 15 Programming/Erasing the Flash Memory (1/2)

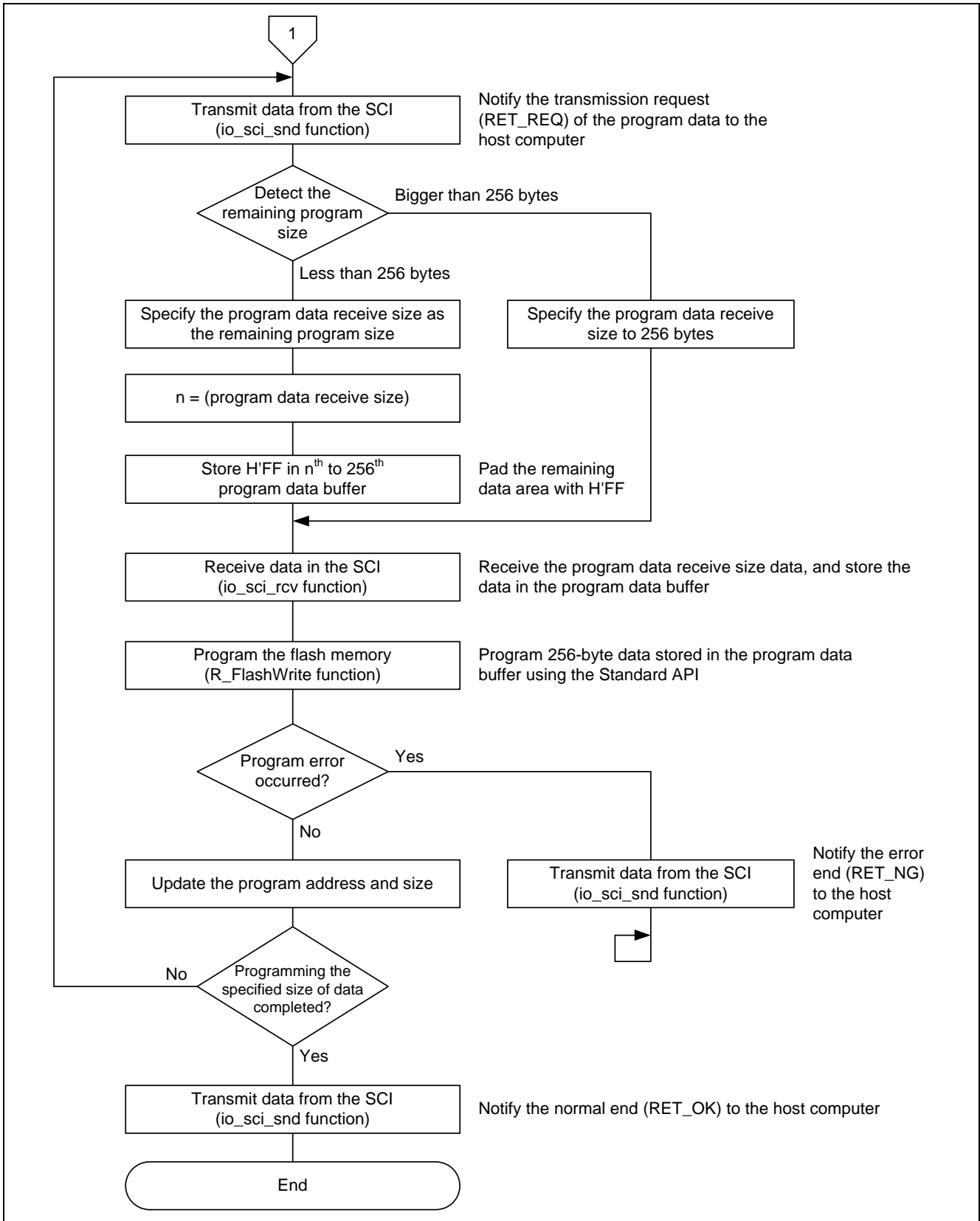


Figure 16 Programming/Erasing the Flash Memory (2/2)

4.4.3 Reading the Flash Memory

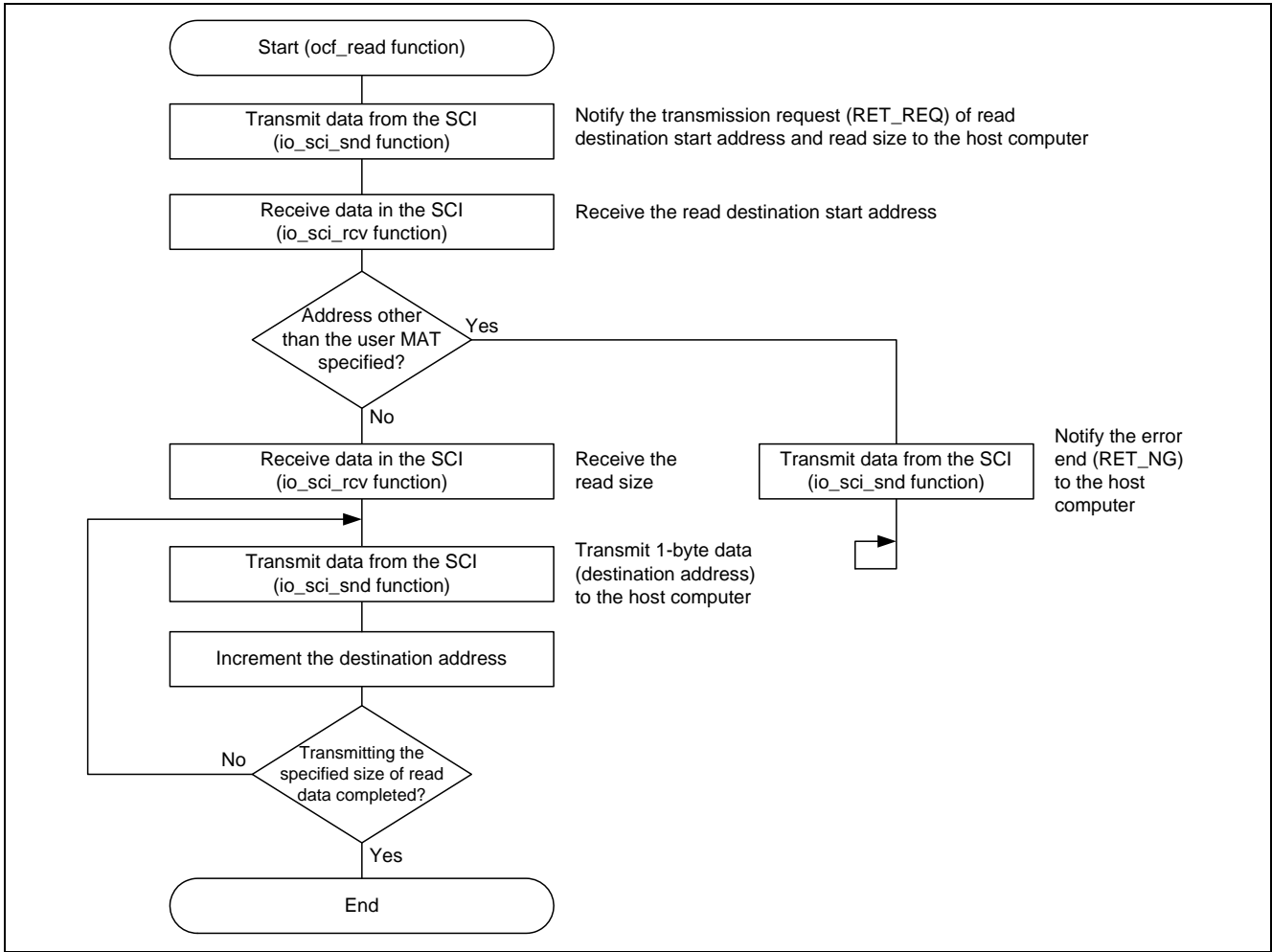


Figure 17 Reading the Flash Memory

4.4.4 Checking the Flash Memory is Program-/Erase-enabled

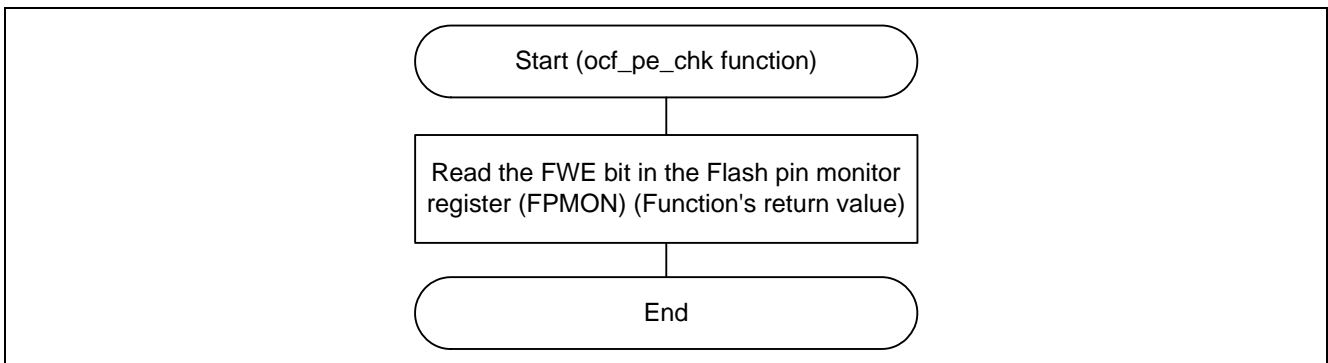


Figure 18 Checking the Flash Memory is Program-/Erase-enabled

5. Sample Program Listing

5.1 Sample Program Listing "main.c" (1/6)

```

1  /*****
2  *   DISCLAIMER
3  *
4  *   This software is supplied by Renesas Electronics Corporation and is only
5  *   intended for use with Renesas products.  No other uses are authorized.
6  *
7  *   This software is owned by Renesas Electronics Corporation and is protected under
8  *   all applicable laws, including copyright laws.
9  *
10 *   THIS SOFTWARE IS PROVIDED "AS IS" AND RENESAS MAKES NO WARRANTIES
11 *   REGARDING THIS SOFTWARE, WHETHER EXPRESS, IMPLIED OR STATUTORY,
12 *   INCLUDING BUT NOT LIMITED TO WARRANTIES OF MERCHANTABILITY, FITNESS FOR A
13 *   PARTICULAR PURPOSE AND NON-INFRINGEMENT.  ALL SUCH WARRANTIES ARE EXPRESSLY
14 *   DISCLAIMED.
15 *
16 *   TO THE MAXIMUM EXTENT PERMITTED NOT PROHIBITED BY LAW, NEITHER RENESAS
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18 *   FOR ANY DIRECT, INDIRECT, SPECIAL, INCIDENTAL OR CONSEQUENTIAL DAMAGES
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21 *
22 *   Renesas reserves the right, without notice, to make changes to this
23 *   software and to discontinue the availability of this software.
24 *   By using this software, you agree to the additional terms and
25 *   conditions found by accessing the following link:
26 *   http://www.renesas.com/disclaimer
27 *****/
28 *   Copyright (C) 2010 Renesas Electronics Corporation. All rights reserved.
29 *****/
30 /*"FILE COMMENT"***** Technical reference data *****/
31 *   System Name : SH7239 Sample Program
32 *   File Name   : main.c
33 *   Abstract    : Using user program mode
34 *   Version     : 1.00.00
35 *   Device      : SH7239
36 *   Tool-Chain  : High-performance Embedded Workshop (Ver.4.07.00).
37 *               : C/C++ compiler package for the SuperH RISC engine family
38 *               :                               (Ver.9.03 Release02).
39 *   OS          : None
40 *   H/W Platform: R0K572390 (CPU board)
41 *   Description :
42 *****/
43 *   History     : Sep.24,2010 Ver.1.00.00
44 *"FILE COMMENT END"*****/
45 #include "iodefine.h"
46 #include "Flash_API_SH7239.h"
47

```


5.2 Sample Program Listing "main.c" (2/6)

```

48  /* ==== Macro definition ==== */
49  #define FLASH_PE_ENABLE      1      /* Flash program/erase enabled      */
50  #define FLASH_PE_DISABLE    0      /* Flash program/erase disabled    */
51  #define CMD_WRITE           0x50   /* Flash memory erasing/programming command */
52  #define CMD_READ            0x52   /* Flash memory reading command */
53  #define RET_OK               0x00   /* Normal end */
54  #define RET_NG               0x01   /* Error end */
55  #define RET_REQ              0x11   /* Transmission request */
56
57  /* ==== Prototype declaration ==== */
58  void main(void);
59  int ocf_pe_chk(void);
60  void ocf_write(void);
61  void ocf_read(void);
62  /* ---- External reference ---- */
63  extern void io_sci_init(void);
64  extern int io_sci_chk_rcv(void);
65  extern void io_sci_snd(unsigned char data);
66  extern void io_sci_rcv(unsigned char *data, unsigned long num);
67
68  /* ==== Global variable ==== */
69  #pragma section WriteDATA /* Program data buffer area */
70  unsigned char WriteBuff[PROGRAM_SIZE_ROM]; /* Program data area */
71
72
73  #pragma section FRAM
74  /*"FUNC COMMENT"*****
75  * ID          :
76  * Outline     : Sample program main
77  *-----
78  * Include     : "iodefine.h" and "flash.h"
79  *-----
80  * Declaration : void main(void);
81  *-----
82  * Function    :
83  *-----
84  * Argument    : void
85  *-----
86  * Return Value : void
87  *-----
88  * Note        : None
89  *"FUNC COMMENT END"*****/
90  void main(void)
91  {
92      unsigned char RcvData;
93      int pe_ok;
94
95      /* ==== Configures the SCI ==== */
96      io_sci_init();
97

```

5.3 Sample Program Listing "main.c" (3/6)

```

98     /* ==== Checks the flash memory is program-/erase-enabled ==== */
99     do{
100         pe_ok = ocf_pe_chk();      /* FWE pin = High ? */
101     }while(pe_ok != FLASH_PE_ENABLE);
102
103     /* ==== Notifies the transmission request to the host computer ==== */
104     io_sci_snd(RET_REQ);
105
106     /* ==== Programs/erases the flash memory or reads the flash memory ==== */
107     while(1){
108         /* ---- Checks the user control command ---- */
109         if(io_sci_chk_rcv() != 0){
110             io_sci_rcv(&RcvData, 1);
111             if(RcvData == CMD_WRITE){
112                 ocf_write();        /* Erases or programs the flash memory */
113             }
114             else if(RcvData == CMD_READ){
115                 ocf_read();         /* Reads the flash memory */
116             }
117         }
118     }
119 }
120
121 /*"FUNC COMMENT"*****
122 * ID          :
123 * Outline     : Flash memory program-/erase-enabled state check
124 *-----
125 * Include     : "iodefine.h"
126 *-----
127 * Declaration : int ocf_pe_chk(void);
128 *-----
129 * Description : Reads the FWE bit in the Flash pin monitor register (FPMON) and
130 *              : returns the value.
131 *-----
132 * Argument    : void
133 *-----
134 * Return Value : 0 ; Flash memory is program-/erase-disabled
135 *              : 1 ; Flash memory is program-/erase-enabled
136 *-----
137 * Note        : None
138 *"FUNC COMMENT END"*****/
139 int ocf_pe_chk(void)
140 {
141     return FLD.FPMON.BIT.FWE;
142 }
143

```

5.4 Sample Program Listing "main.c" (4/6)

```

144 /*"FUNC COMMENT"*****
145 * ID      :
146 * Outline : Programming/erasing the flash memory
147 * -----
148 * Include : "iodefine.h" and "flash.h"
149 * -----
150 * Declaration : void ocf_write(void);
151 * -----
152 * Description : Erases blocks between EB01 and EB14, and programs the specified
153 *              : bytes of data from the destination start address which is
154 *              : specified by the host computer.
155 * -----
156 * Argument   : void
157 * -----
158 * Return Value : void
159 * -----
160 * Note       : None
161 *"FUNC COMMENT END"*****/
162 void ocf_write(void)
163 {
164     unsigned char error;          /* Function return value */
165     unsigned char RcvData;        /* Receive data */
166     unsigned char EraseBlkNum;    /* Erase block number */
167     unsigned long i;              /* Loop counter */
168     unsigned long WriteAddr;     /* Start address to be programmed */
169     unsigned long WriteSize;     /* Data size to be programmed */
170     unsigned long RcvSize;       /* Receiving size for data to be programmed */
171
172     /* ==== Erases blocks ==== */
173     for(EraseBlkNum = BLOCK_1; EraseBlkNum <= BLOCK_14; EraseBlkNum++){
174         /* Erases EB01 to EB14 */
175         error = R_FlashErase((uint8_t)EraseBlkNum);
176         if(error != RET_OK){          /* Erase error? */
177             io_sci_snd(RET_NG);      /* Error end */
178             while(1){
179                 }
180         }
181     }
182
183     /* ==== Transmission request ==== */
184     io_sci_snd(RET_REQ);
185
186     /* ==== Receives the program destination start address ==== */
187     io_sci_rcv((unsigned char *)&WriteAddr, 4);
188     if( (WriteAddr >= 0x00000000) && (WriteAddr < 0x00002000) ){
189         /* EB00 is specified as the destination? */
190         io_sci_snd(RET_NG);          /* Error end */
191         while(1){
192             }
193     }
194 }

```

5.5 Sample Program Listing "main.c" (5/6)

```
195     /* ==== Receives the program data size ==== */
196     io_sci_rcv((unsigned char *)&WriteSize, 4);
197
198     /* ==== Programs the flash memory ==== */
199     while(WriteSize > 0){
200         io_sci_snd(RET_REQ);           /* Transmission request */
201
202         if(WriteSize > PROGRAM_SIZE_ROM){
203             RcvSize = PROGRAM_SIZE_ROM;
204         }
205         else{
206             RcvSize = WriteSize;
207             for(i = RcvSize; i < PROGRAM_SIZE_ROM; i++){
208                 WriteBuff[i] = 0xff;
209             }
210         }
211
212         /* ---- Receives the program data ---- */
213         io_sci_rcv(WriteBuff, RcvSize);
214
215         /* ---- Programs the flash memory ---- */
216         error = R_FlashWrite((uint32_t)WriteAddr, (uint32_t)WriteBuff, PROGRAM_SIZE_ROM);
217         if(error != 0){                /* Program error? */
218             io_sci_snd(RET_NG);        /* Error end */
219             while(1){
220             }
221         }
222
223         WriteAddr += PROGRAM_SIZE_ROM;
224         WriteSize -= RcvSize;
225     }
226
227     io_sci_snd(RET_OK);                /* Normal end */
228 }
229
```

5.6 Sample Program Listing "main.c" (6/6)

```

230  /*"FUNC COMMENT"*****
231  * ID      :
232  * Outline : Reading the flash memory
233  * -----
234  * Include : "flash.h"
235  * -----
236  * Declaration : void ocf_read(void);
237  * -----
238  * Description : Reads the specified size of data from the read destination
239  *              : start address and transmits the data to the host computer.
240  * -----
241  * Argument   : void
242  * -----
243  * Return Value : void
244  * -----
245  * Note       : None
246  *"FUNC COMMENT END"*****/
247  void ocf_read(void)
248  {
249      unsigned char *ReadData; /* Pointer for readout data */
250      unsigned long ReadAddr;  /* Start address to be read */
251      unsigned long ReadSize;  /* Reading size */
252      unsigned long i;         /* Loop counter */
253
254      /* ==== Transmission request ==== */
255      io_sci_snd(RET_REQ);
256
257      /* ==== Receives the read destination start address ==== */
258      io_sci_rcv((unsigned char *)&ReadAddr, 4);
259      if(ReadAddr >= 0x00080000){
260          /* Specified the address other than the read address? */
261          io_sci_snd(RET_NG);          /* Error end */
262          while(1){
263              }
264          }
265
266      /* ==== Receives the read data size ==== */
267      io_sci_rcv((unsigned char *)&ReadSize, 4);
268
269      /* ==== Transmits the data which is read from ROM ==== */
270      ReadData = (unsigned char *)ReadAddr;
271      for(i = 0; i < ReadSize; i++){
272          io_sci_snd(*ReadData++);
273      }
274  }
275
276  /* End of File */

```

6. References

- Hardware Manual
SH7239 Group, SH7237 Group User's Manual: Hardware Rev. 1.00
The latest version of the hardware manual can be downloaded from the Renesas Electronics website.
- Software Manual
SH-2A SH2A-FPU Software Manual Rev. 3.00
The latest version of the software manual can be downloaded from the Renesas Electronics website.

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Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Dec.20.10	–	First edition issued
1.01	Jun.15.12	–	Update sample codes (Simple Flash API revised) Update Notice Page

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins

Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable.

When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to one with a different type number, confirm that the change will not lead to problems.

- The characteristics of MPU/MCU in the same group but having different type numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different type numbers, implement a system-evaluation test for each of the products.

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